

# 6<sup>th</sup> Generation CoolSiC™

#### 650V SiC Schottky Diode

The CoolSiC<sup>TM</sup> generation 6 (G6) is the leading edge technology from Infineon for the SiC Schottky barrier diodes. The Infineon proprietary innovative G5 technology was enhanced in G6 by introducing further advancements like a novel Schottky metal system. The result is a family of products with improved efficiency over all load conditions, resulting from a lower figure of merit ( $Q_c \times V_F$ ). The CoolSiC<sup>TM</sup> Schottky diode 650 V G6 has been designed to complement our 600 V and 650 V CoolMOS<sup>TM</sup> 7 families, meeting the most stringent application requirements in this voltage range.

Table 1 Key performance parameters

Parameter	Value	Unit				
$V_{RRM}$	650	V				
$Q_C (V_R = 400 \text{ V})$	17.1	nC				
$\overline{E_C (V_R = 400 \text{ V})}$	3.2	μJ				
$I_F (T_C \le 140 {}^{\circ}\text{C}, D = 1)$	12	А				
$V_F (I_F = 12 \text{ A}, T_j = 25 \text{ °C})$	1.25	V				

Table 2	Package information
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Type / ordering Code	Package	Marking
IDH12G65C6	PG-TO220-2	D1265C6

# PG-TO220-2 CASE 1) Cathode 2) Anode 1 O O CASE

#### **Features**

- Best in class forward voltage (1.25 V)
- Best in class figure of merit  $(Q_c \times V_F)$
- High dv/dt ruggedness (150 V/ns)

#### **Benefits**

- System efficiency improvement
- System cost and size savings due to the reduced cooling requirements
- Enabling higher frequency and increased power density

#### **Potential Applications**

- · Power factor correction in SMPS
- Solar inverter
- Uninterruptible power supply

#### **Product Validation**

Qualified for industrial applications according to the relevant tests of JEDEC (J-STD20 and JESD22)

**Final Datasheet** 

Please read the Important Notice and Warnings at the end of this document

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#### IDH12G65C6



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# 1 Maximum ratings

Table 3 Maximum ratings

Damamatan	Complete	Values			11:4	/ <del></del>	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note/Test condition	
		-	_	12		$T_C \le 140 {}^{\circ}\text{C}, D = 1$	
Continuous forward current	$I_F$	-	_	15		$T_C \le 125 {}^{\circ}\text{C}, D = 1$	
		-	-	27		$T_C \leq 25$ °C, $D = 1$	
Surge-repetitive forward current, sine halfwave <sup>1</sup>	$I_{F,RM}$	-	_	53	A	$T_C = 25 ^{\circ}\text{C}, t_p = 10 \text{ms}$	
Surge non-repetitive forward		-	_	64		$T_C = 25  ^{\circ}\text{C}, t_p = 10  \text{ms}$	
current, sine halfwave	$I_{F,SM}$	-	_	51		$T_C = 150  ^{\circ}\text{C}, t_{\rho} = 10  \text{ms}$	
Non-repetitive peak forward current	I <sub>F,max</sub>	-	-	630		$T_C$ = 25 °C, $t_p$ = 10 μs	
:24	( :2 al 4	-	-	21	A2-	$T_C = 25 ^{\circ}\text{C}, t_p = 10 \text{ms}$	
i <sup>2</sup> t value	∫i²dt	_	-	13	A <sup>2</sup> s	$T_C = 150  ^{\circ}\text{C},  t_{\rho} = 10  \text{ms}$	
Repetitive peak reverse voltage	$V_{RRM}$	_	-	650	V	<i>T<sub>C</sub></i> = 25 °C	
Diode dv/dt ruggedness	dv/dt	_	_	150	V/ns	V <sub>R</sub> = 0480 V	
Power dissipation	P <sub>tot</sub>	_	_	81	W	$T_C = 25$ °C, $R_{thJC,max}$	
Operating and storage temperature	$T_j$ $T_{stg}$	-55	-	175	°C	-	
Mounting torque	_	_	_	70	Ncm	M3 screw	

## 2 Thermal characteristics

Table 4 Thermal characteristics (PG-TO-220-2)

Dougraphou	Symbol		Values		Unit	Note/Test condition
Parameter		Min.	Тур.	Max.		
Thermal resistance, junction- case	$R_{thJC}$	-	1.1	1.9	12/\AI	_
Thermal resistance, junction- ambient	$R_{thJA}$	_	_	62	K/W	leaded
Soldering temperature, wavesoldering only allowed at leads	$T_{sold}$	-	-	260	°C	1.6 mm (0.063 in.) from case for 10 s

<sup>&</sup>lt;sup>1</sup> The surge-repetitive forward current test was performed with 1000 pulses (half-wave rectified sine with the 10 ms period).

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## 3 Electrical characteristics

#### 3.1 Static characteristics

Table 5Static characteristics

Parameter	Symbol	Values			l lmia	Note /Test condition
		Min.	Тур.	Max.	Unit	Note/Test condition
DC blocking voltage	$V_{DC}$	650	_	_		<i>T<sub>j</sub></i> = 25 °C
Diode forward voltage	$V_F$	_	1.25	1.35	V	$I_F = 12 \text{ A}, T_j = 25 \text{ °C}$
		_	1.5	_		$I_F = 12 \text{ A}, T_j = 150 \text{ °C}$
Reverse current	$I_R$	_	1.2	40	μΑ	$V_R = 420 \text{ V}, T_j = 25 \text{ °C}$
		_	40	_		$V_R = 420 \text{ V}, T_j = 125 \text{ °C}$
		_	92	_		$V_R = 420 \text{ V}, T_j = 150 \text{ °C}$

## 3.2 AC characteristics

#### Table 6 AC characteristics

Parameter	Complete	Values			l lmia	Nata/Task Can dikian
	Symbol	Min.	Тур.	Max.	Unit	Note/Test Condition
Total capacitive charge	$Q_c$	_	17.1	_	nC	$V_R$ = 400 V, $T_j$ = 150 °C, di/dt = 200 A/ $\mu$ s, $I_F \le I_{F,MAX}$
	Capacitance C –	-	594	-		$V_R = 1 \text{ V, } f = 1 \text{ MHz,}$ $T_j = 25 \text{ °C}$
Total Capacitance		35	-	pF	$V_R = 300 \text{ V}, f = 1 \text{ MHz},$ $T_j = 25 \text{ °C}$	
		-	34	_		$V_R$ = 600 V, $f$ = 1 MHz, $T_j$ = 25 °C



## 4 Diagrams

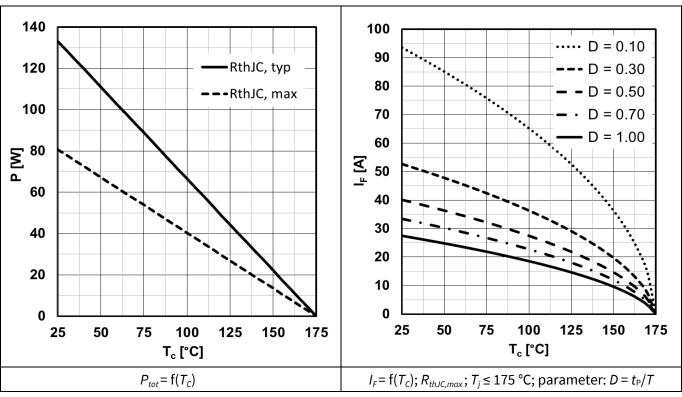


Figure 1 Power dissipation

Figure 2 Max. forward current

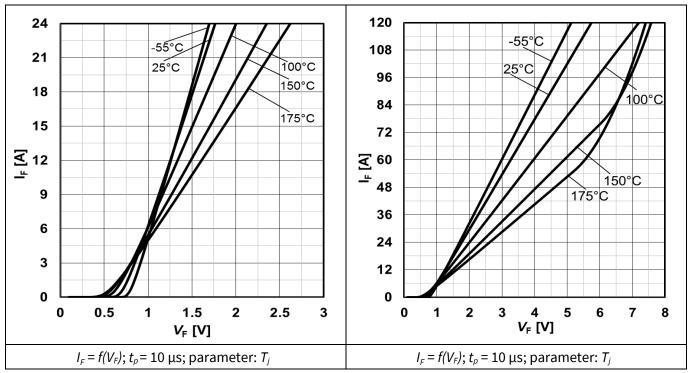


Figure 3 Typ. forward characteristics

Figure 4 Typ. forward characteristics in surge current



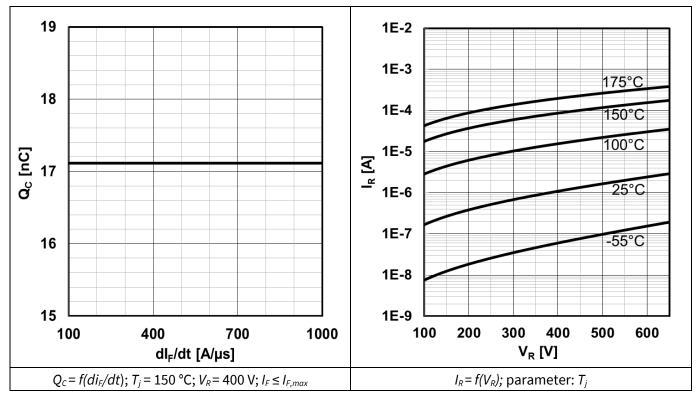


Figure 5 Typ. cap. charge vs. current slope

Figure 6 Typ. reverse current vs. reverse voltage

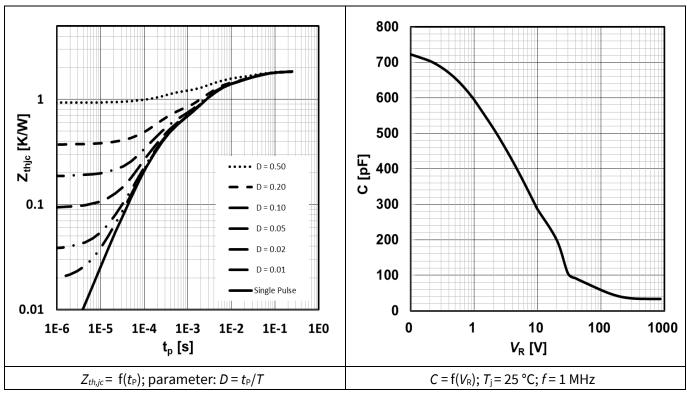


Figure 7 Max. transient thermal impedance

Figure 8 Typ. capacitance vs. reverse voltage



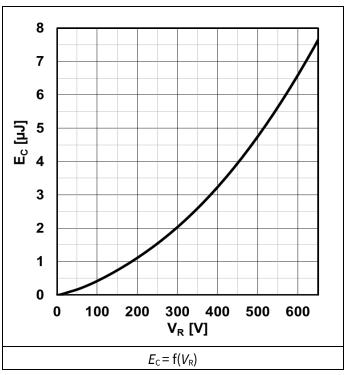


Figure 9 Typ. capacitance stored energy

# 5 Simplified forward characteristic

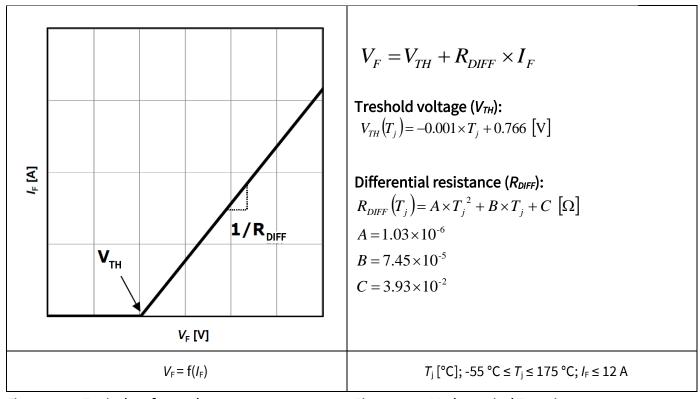


Figure 10 Equivalent forward current curve

Figure 11 Mathematical Equation



# 6 Package outlines

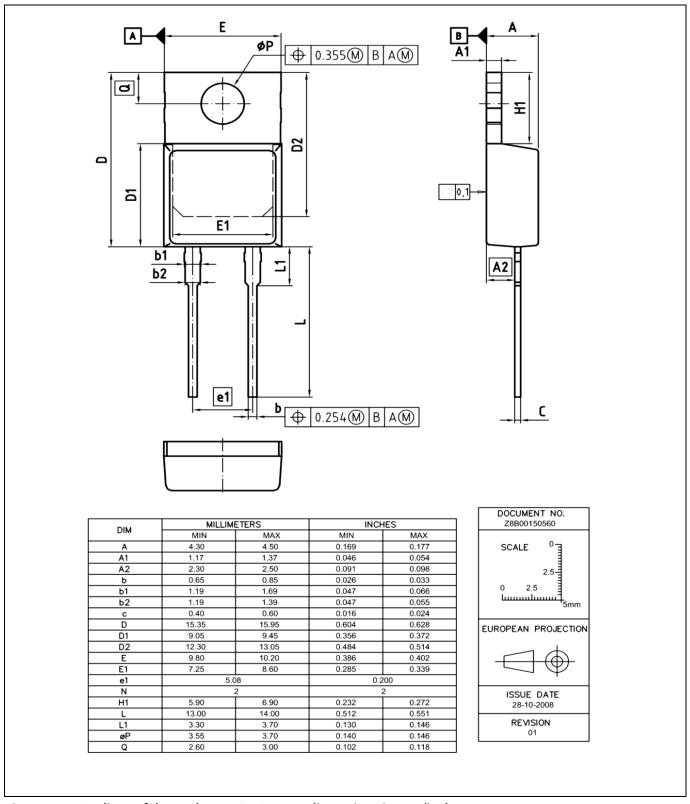


Figure 12 Outlines of the package PG-TO220-2, dimensions in mm/inches

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#### IDH12G65C6



## **Revision History**

## Major changes since the last revision

Revision	Date	Subject (major changes since last revision)
2.0	2017-05-23	Release of final version

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Document reference

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